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THIS DEVICE IS NOT RE

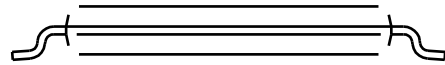
DI

TSSOP48 12.5x6.1



LAND PATTERN RECOMMENDATION

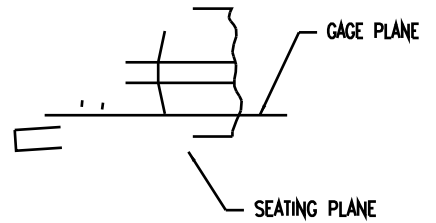
SEE DETAIL A



DIMENSIONS ARE IN MILLIMETERS

AND TIE BAR EXTRUSIONS.

4.



DETAIL A

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